

on Semiconductor® FGD3N60LSD IGBT

Features

- High Current Capability
- Very Low Saturation Voltage : V_{CE(sat)} = 1.2 V @ I_C = 3A
- High Input Impedance

Applications

- HID Lamp Applications
- Piezo Fuel Injection Applications





ON Semiconductor's Insulated Gate Bipolar Transistors

(IGBTs) provide very low conduction losses. The device is

designed for applica-tions where very low On-Voltage Drop is

Description

a required feature.

Absolute Maximum Ratings

Symbol	Description		FGD3N60LSD	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 25	V
I _C	Collector Current	@ T _C = 25°C	6	А
	Collector Current	@ T _C = 100°C	3	А
I _{CM (1)}	Pulsed Collector Current	(1)	25	А
lf	Diode Continous Forward Current	@ T _C = 100°C	3	А
I FM	Diode Maximum Forward Current		25	А
P _D	Maximum Power Dissipation	@ T _C = 25°C	40	W
	Derating Factor		0.32	W/°C
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
Τ _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		250	°C

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
R _{0JC} (IGBT)	Thermal Resistance, Junction-to-Case		3.1	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient (PCB Mount) (2)		100	°C/W

Notes :

(2) Mounted on 1" squre PCB (FR4 or G-10 Material)

FGD3N60LSD IGBT

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGD3N60LSD	FGD3N60LSDTM	D-PAK	380mm	16mm	2500

Electrical Characteristics of the IGBT $T_{c} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charact	eristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	600			V
$\Delta B_{VCES}/\Delta T_J$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0V, I _C = 1mA		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Charact	eristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 3mA, V _{CE} = V _{GE}	2.5	3.2	5.0	V
V _{CE(sat)}	Collector to Emitter	I _C = 3A, V _{GE} = 10V		1.2	1.5	V
- ()	Saturation Voltage	I _C = 6A, V _{GE} = 10V		1.8		V
Dynamic Cl	baractoristics					1
Gia		$V_{05} = 25 V V_{05} = 0 V$		185		рF
Case	Output Capacitance	f = 1MHz		20		p. pF
C	Reverse Transfer Capacitance			55		p. pF
eres				010		ρ.
Switching C	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{CC} = 480 V, I _C = 3A,		40		ns
t _r	Rise Time	R _G = 470Ω, V _{GE} = 10V, – Inductive Load, T _C = 25°C –		40		ns
t _{d(off)}	Turn-Off Delay Time			600		ns
t _f	Fall Time			600		ns
Eon	Turn-On Switching Loss			250		uJ
E _{off}	Turn-Off Switching Loss			1.00		mJ
E _{ts}	Total Switching Loss			1.25		mJ
t _{d(on)}	Turn-On Delay Time	V _{CC} = 480 V, I _C = 3A,		40		ns
t _r	Rise Time	R_{G} = 470 Ω , V_{GE} = 10V, Inductive Load, T_{e} = 125°C		45		ns
t _{d(off)}	Turn-Off Delay Time	$= 125^{\circ}C$		620		ns
t _f	Fall Time			800		ns
Eon	Turn-On Switching Loss			300		uJ
E _{off}	Turn-Off Switching Loss			1.9		mJ
E _{ts}	Total Switching Loss			2.2		mJ
Qg	Total Gate Charge	V _{CE} = 480 V, I _C = 3A,		12.5		nC
Q _{ge}	Gate-Emitter Charge	V _{GE} = 10V		2.8		nC
Q _{gc}	Gate-Collector Charge			4.9		nC
L _e	Internal Emitter Inductance	Measured 5mm from PKG		7.5		nH

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Symbol	Parameter Diode Forward Voltage	Test Conditions		Min.	Тур.	Max.	Units
		I _F = 3A	T _C = 25°C		1.5	1.9	V
			T _C = 100°C		1.55		
t _{rr}	Diode Reverse Recovery Time	I _F = 3A, di/dt = 100A/us - V _R = 200V	T _C = 25°C		234		ns
			T _C = 100°C				
Irr	Diode Peak Reverse Recovery Current		T _C = 25°C		2.64		Α
			T _C = 100°C				
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C		309		nC
			T _C = 100°C				

Typical Performance Characteristics

Figure 1. Typical Output Characteristics











Figure 2. Typical Output Characteristics



Figure 4. Transfer Characteristics



Figure 6. Capacitance Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Gate Charge







Figure 11. Turn-On Characteristics vs. Collector Current



Figure 8. Turn-On Characteristics vs. Gate Resistance



Figure 10. Switching Loss vs. Gate Resistance



Figure 12. Turn-Off Characteristics vs. Collector Current







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